

Special Issue

Spark Plasma Sintering of Materials

Message from the Guest Editor

Spark plasma sintering is attracting significant interests for the processing of difficult-to-sinter and advanced materials including bulk amorphous alloys, nanostructured and fine-grained materials, ultra high temperature ceramics, nanocomposites, and coatings. This Special Issue aims to highlight the recent developments related to processing/synthesis, process modelling, microstructure/properties characterization, and scalability for spark plasma sintering of materials.

Guest Editor

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Message from the Editor-in-Chief

Technologies, provides a single focus for reporting on developments of all technologies, regardless of their application. It is our intention that *Technologies* becomes the journal of choice for both researchers wanting to publish their work and technologists wishing to exploit the high quality research across a wide range of potential applications. Through its open access policy, its quick publication cycle, *Technologies* will facilitate the rapid uptake and development of the research presented, ultimately providing benefit to the wider society.

Editor-in-Chief

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